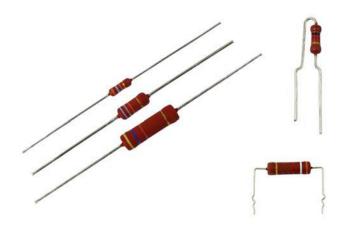


Power Metal Film Leaded Resistors



FEATURES

 High power in small packages (1 W / 0207 size to 3 W / 0617 size)



ROHS COMPLIANT HALOGEN

FREE

- Defined fusing characteristics
- Technology: metal film
- Meets active and passive flammability requirements as defined in IEC 60115-1
- AEC-Q200 qualified (PR01 and PR02)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

A homogeneous film of metal alloy is deposited on a high grade ceramic body. After a helical groove has been cut in the resistive layer, tinned connecting wires of electrolytic copper or copper-clad iron are welded to the end-caps. The resistors are coated with a red, non-flammable lacquer which provides electrical, mechanical and climatic protection. This coating is not resistant to aggressive fluxes and cleaning solvents. The encapsulation is resistant to all cleaning solvents in accordance with IEC 60068-2-45.

APPLICATIONS

- · All general purpose power applications
- Automotive electronics
- · Lighting ballast

TECHNICAL SPECIFICATIONS										
DESCRIPTION	PR01	PR02 Cu-lead	PR02 FeCu-lead	PR03 Cu-lead	PR03 FeCu-lead					
DIN size	0207	0411	0411	0617	0617					
Resistance range (1)	0.22 Ω to 1 M Ω	0.33 Ω to 1 M Ω	1 Ω to 1 M Ω	0.68 Ω to 1 M Ω	1 Ω to 1 M Ω					
Resistance tolerance (2)	± 1 %; ± 5 %	± 1 %; ± 5 %	± 1 %; ± 5 %	± 1 %; ± 5 %	± 1 %; ± 5 %					
Temperature coefficient	± 250 ppm/K	± 250 ppm/K	± 250 ppm/K	± 250 ppm/K	± 250 ppm/K					
Rated dissipation, P ₇₀										
1 Ω ≤ <i>R</i>	1 W	2 W	1.3 W	3 W	2.5 W					
R < 1 Ω	0.6 W	1.2 W	-	1.6 W	-					
Thermal resistance (R _{th})	135 K/W	75 K/W	115 K/W	60 K/W	75 K/W					
Operating voltage, U _{max.} AC/DC	350 V	500 V	500 V	750 V	750 V					
E-series		E24,	E96 (± 1 %); E24 (±	5 %)						
Basic specification			IEC 60115-1							
Stability after:										
Endurance test (1000 h, P_{70})		$\Delta R \text{ max.: } \pm (5 \% R + 0.1 \Omega)$								
Damp heat test (56 days)		$\Delta R \text{ max.: } \pm (3 \% R + 0.1 \Omega)$								
Soldering (10 s, 260 °C)		∆R n	nax.: ± (1 % R + 0.	05 Ω)						

Notes

⁽¹⁾ R value is measured with probe distance of 24 mm ± 1 mm using 4-terminal method.

 $^{^{(2)}}$ 1 % tolerance is available for $R_{\rm n}$ -range from 1 Ω upwards.



TERMINATION	TERMINATION WIRE TYPES										
PRODUCT TYPE	PACKAGING CODE	STYLE	MATERIAL	WIRE DIAMETER	PITCH						
	A1, A5, R5	Axial	Cu	0.58 mm	n/a						
	N4	Radial	Cu	0.58 mm	4.8 mm						
PR01	L1	Radial	Cu	0.58 mm	17.8 mm						
	L1	Radial	FeCu	0.58 mm	17.8 mm						
	K1	Radial	FeCu	0.58 mm	12.5 mm						
	A1, R5	Axial	Cu	0.78 mm	n/a						
	A1	Axial	FeCu	0.58 mm	n/a						
PR02	N3, R2	Radial	Cu	0.78 mm	4.8 mm						
FN02	L1	Radial	Cu	0.78 mm	17.8 mm						
	L1	Radial	FeCu	0.58 mm	17.8 mm						
	B1	Radial	FeCu	0.78 mm	15 mm						
	AC	Axial	Cu	0.78 mm	n/a						
	AC	Axial	FeCu	0.58 mm	n/a						
PR03	DC	Radial	Cu	0.78 mm	25.4 mm						
	DC	Radial	FeCu	0.58 mm	25.4 mm						
	PC	Radial	FeCu	0.78 mm	20 mm						

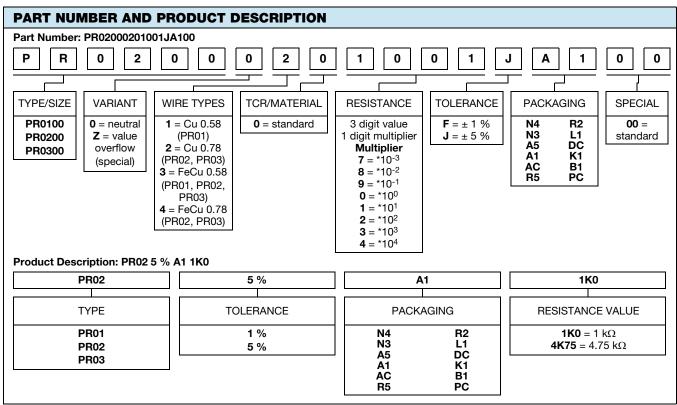
APPLICATION INFORMATION

The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature is not exceeded. Furthermore, a high level of ambient temperature or of power dissipation may raise the temperature of the solder joint, hence special solder alloys or board materials may be required to maintain the reliability of the assembly.

These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime. The designer may estimate the performance of the particular resistor application or set certain load and temperature limits in order to maintain a desired stability.

OPERATION MODE		POWER		
		P ₇₀		
	PR01	1 W		
Rated dissipation	PR02	2 W		
	PR03	3 W		
Applied maximum film temperatu	re, $g_{\rm Fmax.}$	250 °C		
	PR01	0.22 Ω to 1 M Ω		
Max. resistance change at rated dissipation for resistance range:	PR02	0.33 Ω to 1 M Ω		
g.	PR03	0.68 Ω to 1 M Ω		
$ \Delta R/R _{\text{max.}}$ (at P_{70}) after:	1000 h	5.0 % R + 0.1 Ω		





Note

The products can be ordered using either the PRODUCT DESCRIPTION or the PART NUMBER.

PACKAG	PACKAGING									
PRODUCT CODE QUA		QUANTITY	DESCRIPTION	PITCH	TAPE WIDTH	DIMENSION				
	A5	5000	Ammo pack acc. to IEC 60286-1	5 mm	52 mm	75 mm x 114 mm x 260 mm				
	A1	1000	Ammo pack acc. to IEC 60286-1	5 mm	52 mm	78 mm x 31 mm x 260 mm				
PR01	N4	4000	Ammo pack acc. to IEC 60286-2	-	-	45 mm x 262 mm x 330 mm				
PRUI	L1	1000	Loose in bulk	-	-	105 mm x 70 mm x 205 mm				
	K1	1000	Loose in bulk	-	-	105 mm x 70 mm x 205 mm				
	R5	5000	Reel pack acc. to IEC 60286-1	5 mm	52 mm	93 mm x 300 mm x 298 mm				
	A1	1000	Ammo pack acc. to IEC 60286-1	5 mm	52 mm	72 mm x 60 mm x 258 mm				
	N3	3000	Ammo pack acc. to IEC 60286-2	-	-	45 mm x 262 mm x 330 mm				
PR02	L1	1000	Loose in bulk	-	-	105 mm x 70 mm x 205 mm				
PRU2	B1	1000	Loose in bulk	-	-	105 mm x 70 mm x 205 mm				
	R5	5000	Reel pack acc. to IEC 60286-1	5 mm	52 mm	100 mm x 375 mm x 375 mm				
	R2	2000	Reel pack acc. to IEC 60286-2	-	-	90 mm x 375 mm x 375 mm				
	AC	500	Ammo pack acc. to IEC 60286-1	5 mm	63 mm	83 mm x 58 mm x 256 mm				
PR03	DC	500	Loose in bulk	-	-	105 mm x 70 mm x 205 mm				
	PC	500	Loose in bulk	-	-	105 mm x 70 mm x 205 mm				



DESCRIPTION

A homogeneous film of metal alloy is deposited on a high grade ceramic body. After a helical groove has been cut in the resistive layer, tinned connecting wires of electrolytic copper or copper-clad iron are welded to the end-caps. The resistors are coated with a red, non-flammable lacquer conformal coating which provides electrical, mechanical and climatic protection. This coating is not resistant to aggressive fluxes and cleaning solvents. The conformal coating is resistant to all cleaning solvents in accordance with IEC 60068-2-45.

ASSEMBLY

All products comply with the **GADSL** (1) and the **IEC 62474** (2) list of legal restrictions on hazardous substances. This includes full compliance with the following directives:

- 2000/53/EC End of Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the use of Hazardous Substances Directive (RoHS)
- 2012/19/EU Waste Electrical and Electronic Equipment Directive (WEEE)

Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

MATERIALS

Vishay acknowledges the following systems for the regulation of hazardous substances:

- IEC 62474, Material Declaration for Products of and for the Electrotechnical Industry, with the list of declarable substances given therein (3)
- The Global Automotive Declarable Substance List (GADSL) (1)
- The REACH regulation (1907/2006/EC) and the related list of substances with very high concern (SVHC) (4) for its supply chain

The products do not contain any of the banned substances as per IEC 62474, GADSL, or the SVHC list, see www.vishay.com/how/leadfree.

Hence the products fully comply with the following directives:

- 2000/53/EC End-of-Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the Use of Hazardous Substances Directive (RoHS) with amendment 2015/863/EU
- 2012/19/EU Waste Electrical and Electronic Equipment Directive (WEEE)

Vishay pursues the elimination of conflict minerals from its supply chain, see the Conflict Minerals Policy at www.vishay.com/doc?49037.

APPROVALS

The resistors PR01 and PR02 are approved within the AEC-Q200 Quality Assessment System for Electronic Components.

Essentially all tests are carried out in accordance with IEC 60115-1 specification, category -55 °C / +200 °C / 56 days (rated temperature range: lower category temperature, upper category temperature; damp heat, long term, 56 days). The tests are carried out in accordance with IEC 60068-2-xx.

Test method under standard atmospheric conditions according to IEC 60068-1, 5.3.

In the Test Procedures and Requirements table, tests and requirements are listed with reference to the relevant clauses of IEC 60115-1 and IEC 60068-2-xx test methods. A short description of the test procedure is also given. In some instances deviations from the IEC recommendations were necessary for our method of specifying.

All soldering tests are performed with non activated flux.

RELATED PRODUCTS

For more information on products with higher wattage, higher pulse load capability and metal oxide film technology, please refer to the WK/WR datasheet at the link: www.vishay.com/doc?20128

Notes

Revision: 10-Sep-15

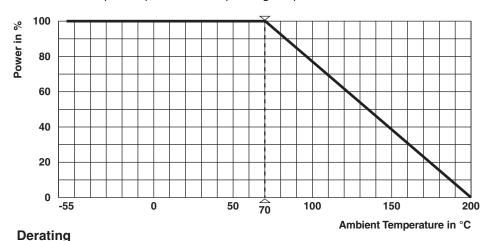
- (1) The Global Automotive Declarable Substance List (GADSL) is maintained by the American Chemistry Council, and available at www.gadsl.org
- (2) EFIC (European Chemical Industry Council), EECA (European Electronic Component Manufacturers Association), EICTA (European trade organisation representing the information and communications technology and consumer electronics), see www.digitaleurope.org/SearchResults.aspx?Search=eicta.
- All products comply with the IEC 62474, Material Declaration for Products of and for the Electrotechnical Industry.

 (3) The IEC 62474 list of declarable substances is maintained in a dedicated database, which is available at http://std.iec.ch/iec62474.
- (4) The SVHC list is maintained by the European Chemical Agency (ECHA) and available at http://echa.europa.eu/candidate-list-table.

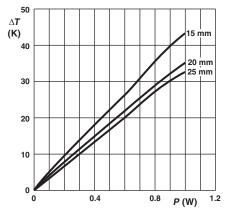


FUNCTIONAL PERFORMANCE

The power that the resistor can dissipate depends on the operating temperature.

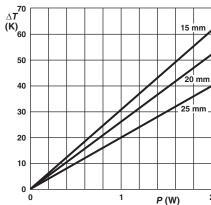


Maximum dissipation (P_{max}) in percentage of rated power as a function of the ambient temperature (T_{amb})



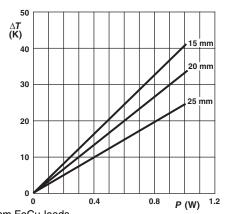
Ø 0.58 mm Cu-leads
Minimum distance from resistor body to PCB = 1 mm

PR01 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



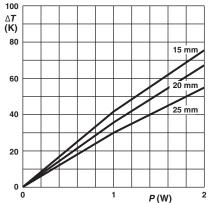
Ø 0.58 mm FeCu-leads Minimum distance from resistor body to PCB = 1 mm

PR02 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø 0.58 mm FeCu-leads Minimum distance from resistor body to PCB = 1 mm

PR01 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.

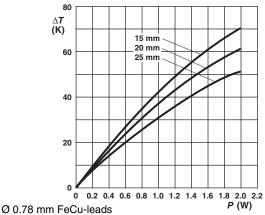


Ø 0.78 mm Cu-leads

Minimum distance from resistor body to PCB = 1 mm

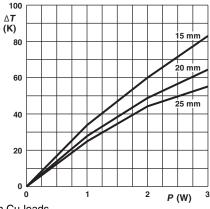
PR02 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.

Vishay BCcomponents



Minimum distance from resistor body to PCB = 1 mm

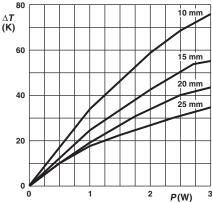
PR02 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø 0.78 mm Cu-leads

Minimum distance from resistor body to PCB = 1 mm

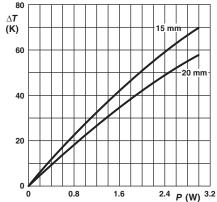
PR03 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø 0.58 mm FeCu-leads

Minimum distance from resistor body to PCB = 1 mm

PR03 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.

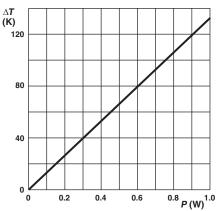


Ø 0.78 mm FeCu-leads

Minimum distance from resistor body to PCB = 1 mm

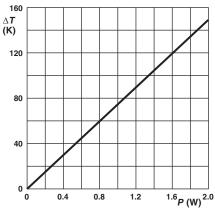
PR03 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.

Vishay BCcomponents



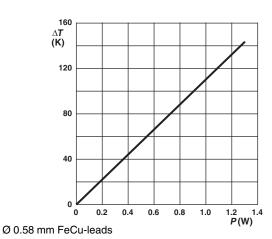
Ø 0.58 mm Cu-leads

PR01 Hot-spot temperature rise (ΔT) as a function of dissipated power.

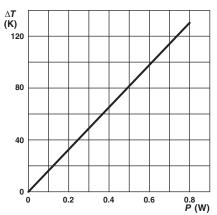


Ø 0.78 mm Cu-leads

PR02 Hot-spot temperature rise (ΔT) as a function of dissipated power.

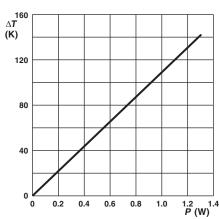


PR02 Hot-spot temperature rise (ΔT) as a function of dissipated power.



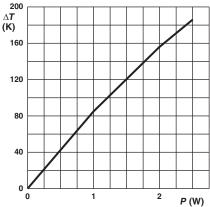
Ø 0.58 mm FeCu-leads

PR01 Hot-spot temperature rise (ΔT) as a function of dissipated power.



Ø 0.78 mm FeCu-leads

PR02 Hot-spot temperature rise (ΔT) as a function of dissipated power.



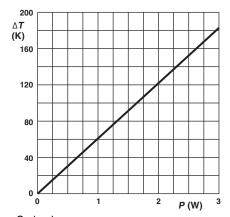
Ø 0.58 mm FeCu-leads

PR03 Hot-spot temperature rise (ΔT) as a function of dissipated power.



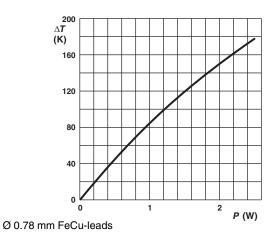


Vishay BCcomponents



Ø 0.78 mm Cu-leads

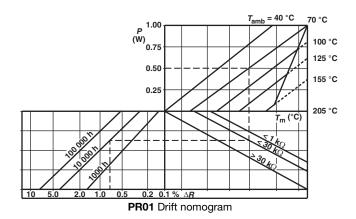
PR03 Hot-spot temperature rise (ΔT) as a function of dissipated power.

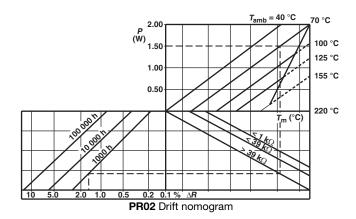


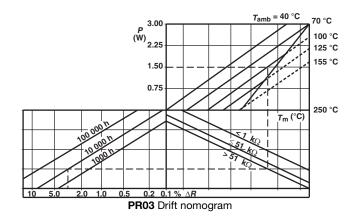
PR03 Hot-spot temperature rise (ΔT) as a function of dissipated power.



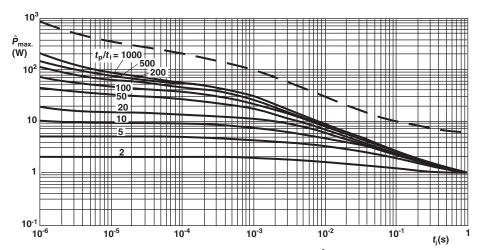
The maximum permissible hot-spot temperature is 205 °C for PR01, 220 °C for PR02 and 250 °C for PR03.



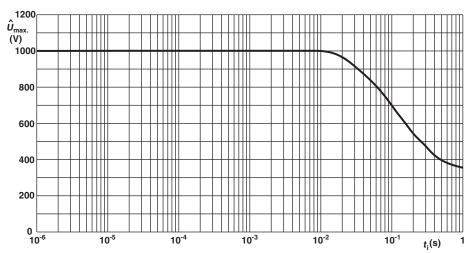




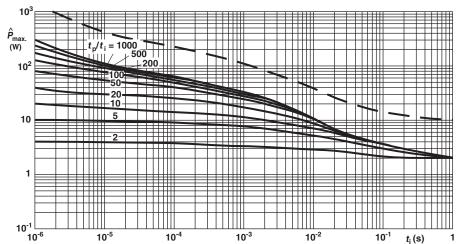




PR01 Pulse on a regular basis; maximum permissible peak pulse power (\hat{P}_{max}) as a function of pulse duration (t_i)

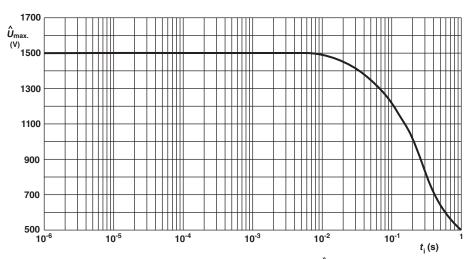


PR01 Pulse on a regular basis; maximum permissible peak pulse voltage (\hat{U}_{max}) as a function of pulse duration (t_i)

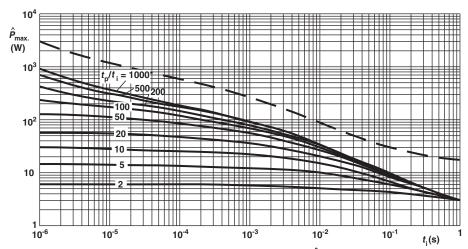


PR02 Pulse on a regular basis; maximum permissible peak pulse power (\hat{P}_{max}) as a function of pulse duration (t_i)

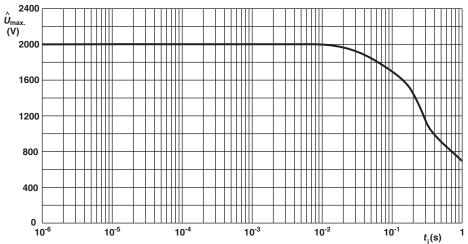




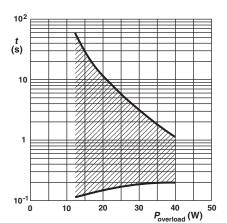
PR02 Pulse on a regular basis; maximum permissible peak pulse voltage (\hat{U}_{max}) as a function of pulse duration (t_i)



PR03 Pulse on a regular basis; maximum permissible peak pulse power (\hat{P}_{max}) as a function of pulse duration (t_i)

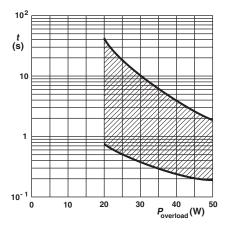


PR03 Pulse on a regular basis; maximum permissible peak pulse voltage (\hat{U}_{max}) as a function of pulse duration (t_i)



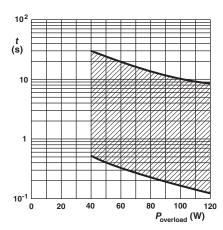
PR01 Time to interruption as a function of overload power for range: $0.22~\Omega \le R_n < 1~\Omega$

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



PR01 Time to interruption as a function of overload power for range: 1 $\Omega \le R_n \le 15 \Omega$

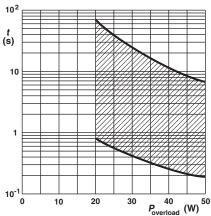
This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



PR02 Time to interruption as a function of overload power for range: $5 \Omega \le R_n \le 68 \Omega$

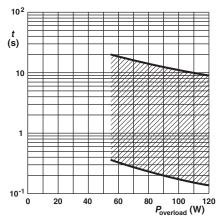
This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.





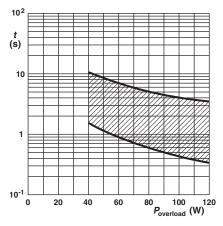
PR01 Time to interruption as a function of overload power for range: 16 $\Omega \le R_n \le 560~\Omega$

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



PR02 Time to interruption as a function of overload power for range: 0.33 $\Omega \le R_n \le 5$ Ω

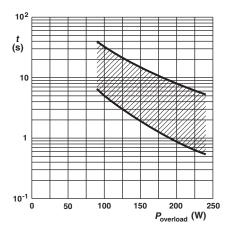
This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



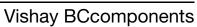
PR02 Time to interruption as a function of overload power for range: 68 $\Omega \le R_n \le 560 \ \Omega$

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.

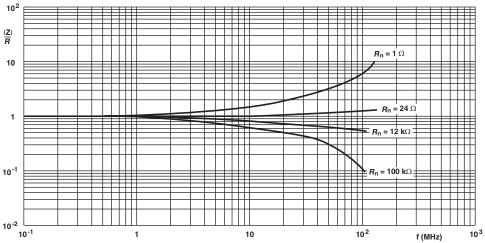




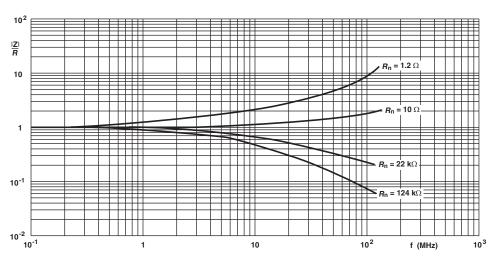
PR03 Time to interruption as a function of overload power for range: $0.68~\Omega \le R_n \le 560~\Omega$ This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



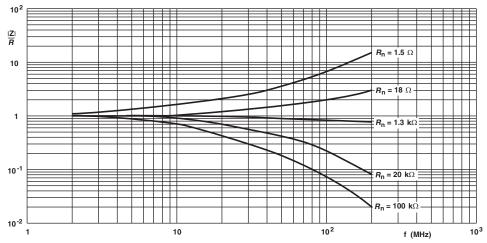




PR01 Impedance as a function of applied frequency



PR02 Impedance as a function of applied frequency



PR03 Impedance as a function of applied frequency



TESTS PROCEDURES AND REQUIREMENTS

All tests are carried out in accordance with the following specifications:

• IEC 60115-1, generic specification (includes tests)

The test and requirements table contains only the most important tests. For the full test schedule refer to the documents listed above.

The tests are carried out in accordance with IEC 60068-2-xx test method and under standard atmospheric conditions in accordance with IEC 60068-1, 5.3.

Climatic category LCT / UCT / 56 (rated temperature range: lower category temperature, upper category temperature; damp heat, steady state, test duration: 56 days) is valid.

Unless otherwise specified the following values apply:

• Temperature: 15 °C to 35 °C

Relative humidity: 45 % to 75 %

• Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar).

For performing some of the tests, the components are mounted on a test board in accordance with IEC 60115-1, 4.31.

In test procedures and requirements table, only the tests and requirements are listed with reference to the relevant clauses of IEC 60115-1 and IEC 60068-2-xx test methods. A short description of the test procedure is also given.

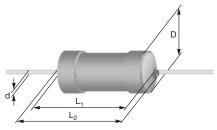
TEST P	FEST PROCEDURES AND REQUIREMENTS								
IEC 60115-1 CLAUSE	IEC 60068-2- TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR _{max.})					
4.4.1	-	Visual examination		No holes; clean surface; no damage					
4.4.2	-	Dimensions (outline)	Gauge (mm)	See Straight and Kinked Dimensions tables					
4.5	-	Resistance		± 5 % R					
4.6.1.1	-	Insulation resistance	Maximum voltage (DC) after 1 min; metal block method	$R_{ins\;min.}$: $10^4\;M\Omega$					
4.7	-	Voltage proof	$U_{RMS} = U_{ins}; 60 \ s$	No breakdown or flashover					
4.8	-	Temperature coefficient	At (20 / -55 / 20) °C and (20 / 155 / 20) °C	≤ ± 250 ppm/K					
4.16	21 (Ua ₁) 21 (Ub) 21 (Uc)	Robustness of terminations	Tensile, bending, and torsion	No damage $\Delta R_{\text{max.}}$: \pm (0.5 % R + 0.05 Ω)					
4.47	00 (Ta)	Oalda abiii	+235 °C; 2 s; solder bath method; SnPb40	Good tinning (≥ 95 % covered, no visible damage)					
4.17	20 (Ta)	Solderability	+245 °C; 3 s; solder bath method; SnAg3Cu0.5	Good tinning (≥ 95 % covered, no visible damage)					
4.18.2	20 (Tb)	Resistance to soldering heat	Unmounted components (260 ± 5) °C; (10 ± 1) s	ΔR_{max} : ± (1 % R + 0.05 Ω)					
4.19	14 (Na)	Rapid change of temperature	30 min at -55 °C and 30 min at +200 °C; 5 cycles	No visual damage PR01 : ΔR_{max} : \pm (1 % R + 0.05 Ω) PR02 : ΔR_{max} : \pm (1 % R + 0.05 Ω) PR03 : ΔR_{max} : \pm (2 % R + 0.05 Ω)					
4.20	29 (Eb)	Bump	3 x 1500 bumps in three directions; 40 g	No damage ΔR _{max} .: ± (0.5 % R + 0.05 Ω)					
4.22	6 (Fc)	Vibration	10 sweep cycles per direction; 10 Hz to 2000 Hz; 1.5 mm or 200 m/s ²	No damage $\Delta R_{\text{max.}}$: ± (0.5 % R + 0.05 Ω)					



TEST P	TEST PROCEDURES AND REQUIREMENTS									
IEC 60115-1 CLAUSE	IEC 60068-2- TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE ($\Delta R_{\rm max.}$)						
4.23		Climatic sequence:								
4.23.2	2 (Ba)	Dry heat	200 °C; 16 h							
4.23.3	30 (Db)	Damp heat, cyclic	55 °C; 24 h; 90 % to 100 % RH; 1 cycle							
4.23.4	1 (Aa)	Cold	-55 °C; 2 h	$R_{\text{ins min.}}$: 10 ³ M Ω						
4.23.5	13 (M)	Low air pressure	8.5 kPa; 2 h; 15 °C to 35 °C	ΔR_{max} : ± (1.5 % R + 0.1 Ω)						
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; 5 days; 95 % to 100 % RH; 5 cycles							
4.24	78 (Cab)	Damp heat (steady state)	(40 ± 2) °C; 56 days; (93 ± 3)% RH	$\Delta R_{\text{max.}}$: ± (3 % R + 0.1 Ω)						
4.25.1	-	Endurance (at 70 °C)	$U = \sqrt{P_{70} \times R}$ or $U = U_{\text{max.}}$; 1.5 h on; 0.5 h off; 70 °C; 1000 h	$\Delta R_{\text{max.}}$: ± (5 % R + 0.1 Ω)						
4.26	-	Active flammability	Accidental overload test	No damage, no flamming of gauze cylinder						
4.29	45 (Xa)	Component solvent resistance	Isopropyl alcohol (used in industrial application) +23 °C; toothbrush method	Marking legible; no visible damage						
4.35	-	Passive flammability	Needle flame test	No ignition of product, no ignition of under layer burning time is less than 30 s						

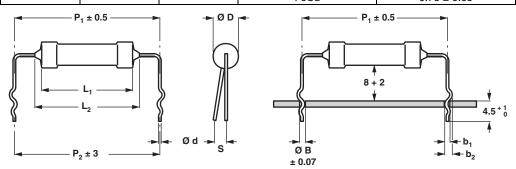


DIMENSIONS



Type with straight leads

DIMENSIONS - Straight lead type and relevant physical dimensions; see straight leads outline										
T /D T	Ø D _{MAX.} L _{1 MAX.} L _{2 MAX.} TERMINATION WIRE MATERIAL (Cu of AND WIRE DIAMETER (Ø d)		MATERIAL (Cu OR FeCu) IAMETER (Ø d)	MASS						
TYPE	(mm)	(mm)	(mm)	MATERIAL	Ø d (mm)	(mg)				
DD01	R01 2.5 6.5	G F	8.0	Cu	0.58 ± 0.05	212				
PRUI		0.5		0.0	FeCu	0.58 ± 0.05	207			
			12.0	12.0	0.0 12.0	Cu	0.78 ± 0.05	504		
PR02	3.9	10.0				12.0	12.0	FeCu	0.58 ± 0.05	455
								FeCu	0.78 ± 0.05	496
				Cu	0.78 ± 0.05	1192				
PR03	5.2	16.7	19.5	FeCu	0.58 ± 0.05	1079				
				FeCu	0.78 ± 0.05	1185				



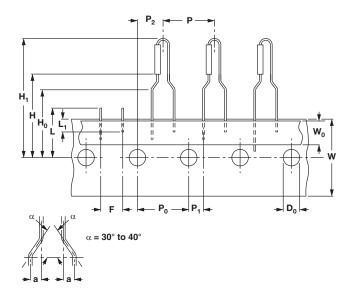
Type with double kink

Dimensions in millimeters

DIMI	DIMENSIONS - Double kink lead type and relevant physical dimensions; see double kinked outline																			
TYPE	Ø D _{MAX.}	L _{1 MAX.} (mm)	L _{2 MAX.}	TERMINATION WIRE MATERIAL (Cu OR FeCu) AND WIRE DIAMETER (Ø d)		MASS (mg)	PITCH (mm)	P ₁ (mm)	P ₂ (mm)	b ₁ (mm)	b ₂ (mm)	S _{MAX.}	Ø B (mm)							
				MATERIAL	Ø d (mm)															
				Cu	0.58 ± 0.05	212	17.8	17.8 ± 0.5	17.8 ± 3	1.10 + 0.25 / - 0.20	1.45 + 0.25 / - 0.20	2	0.8 ± 0.07							
PR01	2.5	6.5	8.0	FeCu	0.58 ± 0.05	207	12.5	12.5 ± 0.5	12.5 ± 3	1.10 + 0.25 / - 0.20	1.45 + 0.25 / - 0.20	2	0.8 ± 0.07							
				FeCu	0.58 ± 0.05	207	17.8	17.8 ± 0.5	17.8 ± 3	1.10 + 0.25 / - 0.20	1.45 + 0.25 / - 0.20	2	0.8 ± 0.07							
		5.9 10.0	10.0	10.0	10.0	10.0	10.0				Cu	0.78 ± 0.05	504	17.8	17.8 ± 0.5	17.8 ± 3	1.10 + 0.25 / - 0.20	1.45 + 0.25 / - 0.20	2	1.0 ± 0.07
PR02	3.9							12.0	FeCu	0.58 ± 0.05	455	17.8	17.8 ± 0.5	17.8 ± 3	1.10 + 0.25 / - 0.20	1.45 + 0.25 / - 0.20	2	0.8 ± 0.07		
				FeCu	0.78 ± 0.05	496	15.0	15.0 ± 0.5	15.0 ± 3	1.30 + 0.25 / - 0.20	1.65 + 0.25 / - 0.20	2	1.0 ± 0.07							
									Cu	0.78 ± 0.05	1192	25.4	25.4 ± 0.5	25.4 ± 3	1.10 + 0.25 / - 0.20	1.65 + 0.25 / - 0.20	2	1.0 ± 0.07		
PR03	5.2	16.7	19.5	FeCu	0.58 ± 0.05	1079	25.4	25.4 ± 0.5	25.4 ± 3	1.10 + 0.25 / - 0.20	1.65 + 0.25 / - 0.20	2	1.0 ± 0.07							
				FeCu	0.78 ± 0.05	1185	20	22.0 ± 0.5	20.0 ± 3	1.30 + 0.25 / - 0.20	2.15 + 0.25 / - 0.20	2	1.0 ± 0.07							

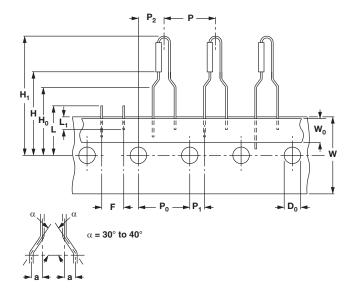
PR01, PR02 WITH RADIAL TAPING

PR01 - Height for insertion (max.) = 32 mm



DIMENSIONS in millimeters		
Pitch of components	Р	12.7 ± 1.0
Feed-hole pitch	P ₀	12.7 ± 0.2
Feed-hole centre to lead at topside at the tape	P ₁	3.85 ± 0.5
Feed-hole center to body center	P ₂	6.35 ± 1.0
Lead spacing	F	4.8 +0.7/-0
Width of carrier tape	W	18.0 ± 0.5
Minimum hold down tape width	W_0	5.5
Height for insertion (max.)	H1	32
Lead wire clinch height	H ₀	16.5 ± 0.5
Body to hole center	Н	19.5 ± 1
Feed-hole diameter	D ₀	4.0 ± 0.2
Height for cutting (max.)	L	11.0
Minimum lead wire (tape portion) shortest lead	L ₁	2.5

PR02 - Height for insertion (max.) = 29 mm



DIMENSIONS in millimeters		
Pitch of components	Р	12.7 ± 1.0
Feed-hole pitch	P ₀	12.7 ± 0.2
Feed-hole centre to lead at topside at the tape	P ₁	3.85 ± 0.5
Feed-hole center to body center	P ₂	6.35 ± 1.0
Lead spacing	F	4.8 +0.7/-0
Width of carrier tape	W	18.0 ± 0.5
Minimum hold down tape width	W_0	5.5
Height for insertion (max.)	H1	29
Lead wire clinch height	H ₀	16.5 ± 0.5
Body to hole center	Н	19.5 ± 1
Feed-hole diameter	D ₀	4.0 ± 0.2
Height for cutting (max.)	L	11.0
Minimum lead wire (tape portion) shortest lead	L ₁	2.5

MARKING

The nominal resistance and tolerance are marked on the resistor using four or five colored bands in accordance with IEC 60062, marking codes for resistors and capacitors.



12NC INFORMATION FOR HISTORICAL CODING REFERENCE

The resistors have a 12-digit numeric code starting with 23 For 5 % tolerance:

- The next 7 digits indicate the resistor type and packing
- The remaining 3 digits indicate the resistance value:
 - The first 2 digits indicate the resistance value
 - The last digit indicates the resistance decade

For 1 % tolerance:

- The next 6 digits indicate the resistor type and packing
- The remaining 4 digits indicate the resistance value:
 - The first 3 digits indicate the resistance value
 - The last digit indicates the resistance decade

Last Digit of 12NC Indicating Resistance Decade

RESISTANCE DECADE	LAST DIGIT
0.22 Ω to 0.91 Ω	7
1 Ω to 9.76 Ω	8
10 Ω to 97.6 Ω	9
100 Ω to 976 Ω	1
1 Ω to 9.76 kΩ	2
10 Ω to 97.6 kΩ	3
100 Ω to 976 k Ω	4
1 ΜΩ	5

12NC Example

The 12NC for resistor type PR02 with Cu leads and a value of 750 Ω with 5 % tolerance, supplied on a bandolier of 1000 units in ammopack, is: 2306 198 53751.

12NC	12NC - Resistor Type and Packaging (1)										
			23 (BANDOLIER)								
	LEAD G	TO.			AMMOPACK				REEL		
TYPE	LEAD Ø mm	TOL. (%)	BADIAI	TAPED		STRAIGH	T LEADS		RADIAL TAPED		
		(70)	HADIAL	IAPED	52 mm	52 mm	63 mm	52 mm	RADIAL TAPED		
			4000 UNITS	3000 UNITS	5000 UNITS	1000 UNITS	500 UNITS	5000 UNITS	2000 UNITS		
PR01	Cu 0.58	1	-	-	22 196 1	06 191 2	-	06 191 5	-		
Phui	Cu 0.56	5	06 197 03	-	22 193 14	06 197 53	-	06 197 23	-		
	Cu 0.70	Cu 0.78	1	-	22 197 2	-	22 197 1	ı	-	2322 197 5	
PR02	Cu 0.76	5	-	06 198 03	-	06 198 53	-	-	2322 198 04		
	FeCu 0.58	5	-	-	-	22 194 54	-	-	-		
	Cu 0.78	5	-	-	-	-	22 195 14	-	-		
PR03	Cu 0.76	1	-	-	-	-	06 199 6	-	-		
	FeCu 0.58	5	-	-	-	-	22 195 54	-	-		

Notes

⁽¹⁾ Other packaging versions are available on request.

12NC	Resistor	Туре	and Packaging			
TYPE	LEAD Ø mm	TOL. (%)	23 (LOOSE IN BOX) DOUBLE KINK			
			1000 UNITS	500 UNITS		
			PR01	Cu 0.58	5	22 193 03
FeCu 0.58	5	22 193 43		-	22 193 53 ⁽²⁾	-
PR02	Cu 0.78	5	22 194 23	-	-	-
	FeCu 0.58	5	22 194 83	-	-	-
	FeCu 0.78	5	-	-	22 194 63 ⁽³⁾	-
PR03	Cu 0.78	5	=	22 195 23	=	-
	FeCu 0.58	5	=	22 195 83	-	-
	FeCu 0.78	5	=	-	-	22 195 63 ⁽⁴⁾

Notes

- Preferred types in bold.
- (2) PR01 pitch 12.5 mm.
- (3) PR02 pitch 15.0 mm.
- (4) PR03 pitch 20.0 mm, with reversed kinking direction as opposed to the drawing for the type with double kink figure.

[·] Preferred types in bold.



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